General Purpose Transistor (Isolated Dual Transistors)

Datasheet

AEC-Q101 Qualified

Parameter	Tr1 and Tr2		
V _{CEO}	-50V		
I _C	-150mA		

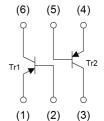
● **Outline**SOT-363 SC-88 UMT6

Features

- 1)Two 2SA1037AK chips in a UMT package.
- 2)Mounting possible with UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4) Mounting cost and area can be cut in half

●Inner circuit

- (1) Tr1 Emitter
- (2) Tr1 Base
- (3) Tr2 Collector
- (4) Tr2 Emitter
- (5) Tr2 Base
- (6) Tr1 Collector



Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
UMT1N FHA	SOT-363 (UMT6)	2021	TN	180	8	3000	T1

● **Absolute maximum ratings** (T_a = 25°C) < It is the same ratings for the Tr1 and Tr2>

Parameter			Values	Unit
Collector-base voltage			-60	V
Collector-emitter voltage			-50	V
Emitter-base voltage			-6	V
Collector current			-150	mA
Device discipation	total	P _D *1	150	mW
Power dissipation element		P_{D}	120	mW
Junction temperature			150	°C
Range of storage temperature			-55 to +150	°C

● Electrical characteristics (T_a = 25°C) < It is the same characteristics for the Tr1 and Tr2>

Downston	Curanh al	Conditions	Values			l lait
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	I _C = -50μA	-60	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-50	-	-	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = -50μA	-6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -60V	-	-	-100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -6V	-	-	-100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -50mA, I _B = -5mA	-	-	-500	mV
DC current gain	h _{FE}	$V_{CE} = -6V$, $I_C = -1mA$	120	-	560	-
Transition frequency	f _T	V _{CE} = -12V, I _E = 2mA, f = 100MHz	-	140	-	MHz
Output capacitance C_{ob} $V_{CB} = -12$ $f = 1MHz$		V _{CB} = -12V, I _E = 0A, f = 1MHz	-	4.0	5.0	pF

^{*1} Each terminal mounted on a reference land.

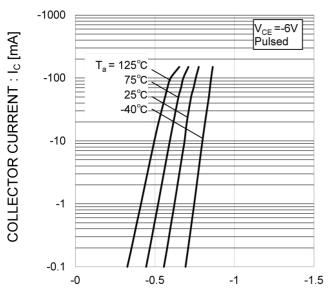
^{*2 120}mW per element must not be exceeded.

^{*3 200}mW per element must not be exceeded.

● Electrical characteristic curves (T_a = 25°C)

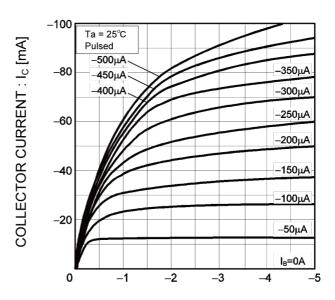
<For Tr1 and Tr2 in common>

Fig.1 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE : V_{BE} [V]

Fig.2 Grounded Emitter Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

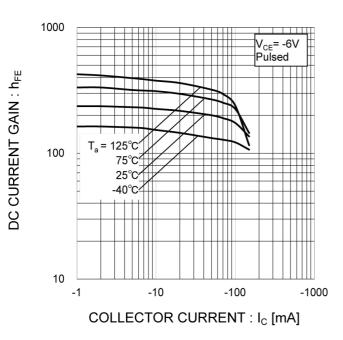
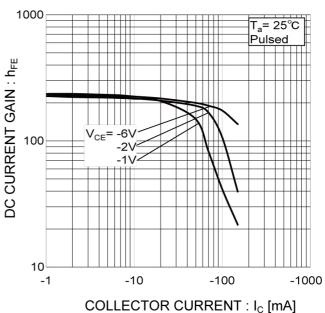


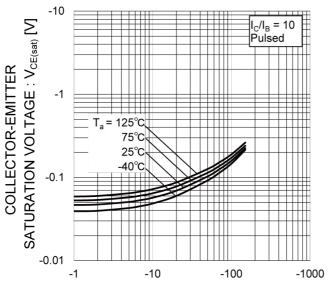
Fig.4 DC Current Gain vs. Collector Current (II)



● Electrical characteristic curves (T_a = 25°C)

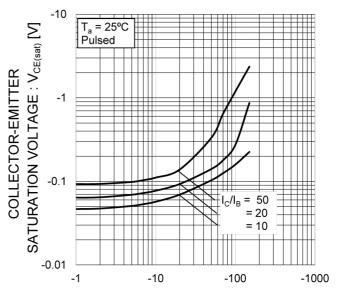
<For Tr1 and Tr2 in common>

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)



COLLECTOR CURRENT: Ic [mA]

Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)



COLLECTOR CURRENT: Ic [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current (I)

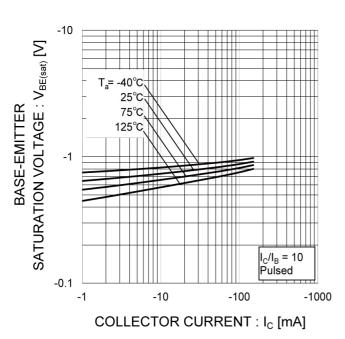
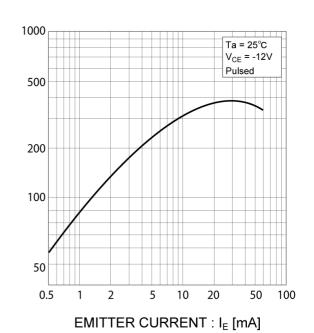


Fig.8 Gain Bandwith Product vs.
Emitter Current



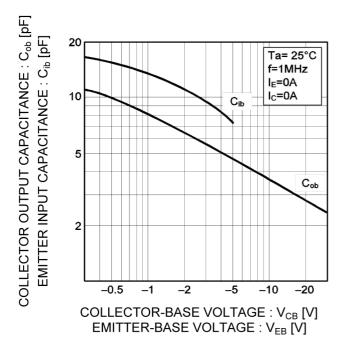
TRANSITION FREQUENCY : fr [MHz]

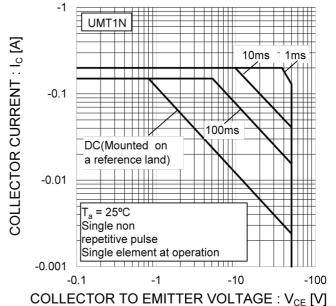
● Electrical characteristic curves (T_a =25°C)

<For Tr1 and Tr2 in common>

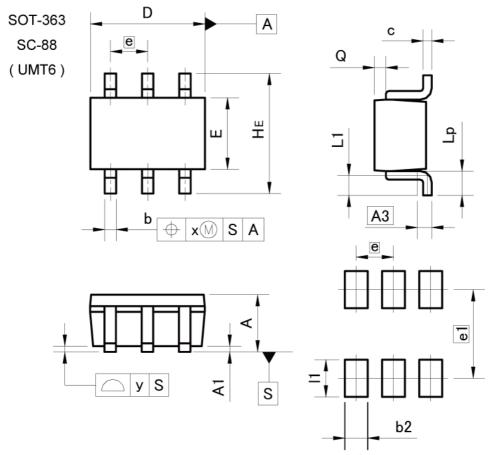
Fig.9 Collector Output Capacitance vs.
Collector-Base Voltage
Emitter Input Capacitance vs.
Emitter-Base Voltage

Fig.10 Safe Operating Area





Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.3	25	0.010		
b	0.15	0.30	0.006	0.012	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35 0.045		0.053	
е	0.0	65	0.026		
HE 2.00		2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022 0.012 0.004	
Q	0.10	0.30 0.004	0.004		
х	-	0.10	-		
у	->	0.10	-	- 0.004	
	A411 TA41	TTEDO.	This is	LIEO	
DIM		ETERS		HES	
eccsonored)	MIN	MAX	MIN	MAX	
b2	- 1	0.40	1 -	0.016	

Dimension in mm/inches

e1 11



0.026

0.061

0.65

1.55

Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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Ť	JÁPAN	USA	EU	CHINA
	CLASSIII	CLASSIII	CLASS II b	СГУССШ
	CLASSIV	CLASSIII	CLASSIII	CLASSII

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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